

V _{CES}	650V
I _{C(100°C)}	50A
V _{CE(sat) (Typ.)}	1.65V
P _D	277W

Features

- 1) Low Collector Emitter Saturation Voltage
- 2) Low Switching Loss
- 3) Short Circuit Withstand Time 5µs
- 4) Built in Very Fast & Soft Recovery FRD (RFN - Series)
- 5) Pb free Lead Plating ; RoHS Compliant

Applications

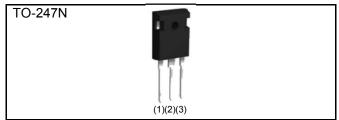
General Inverter

UPS

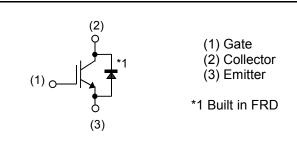
Power Conditioner

Welder

Outline



Inner Circuit



Packaging Specifications

	Packaging	Tube
	Reel Size (mm)	-
Type	Tape Width (mm)	-
Туре	Basic Ordering Unit (pcs)	450
	Packing code	C11
	Marking	RGT00TS65D

•Absolute Maximum Ratings (at T_C = 25°C unless otherwise specified)

		7		
Parameter		Symbol	Value	Unit
Collector - Emitter Voltage		V _{CES}	650	V
Gate - Emitter Voltage		V _{GES}	±30	V
Collector Current	$T_{\rm C}$ = 25°C	Ι _C	85	А
Collector Current	T _C = 100°C	Ι _C	50	А
Pulsed Collector Current	I _{CP} *1	150	А	
Diada Farward Current	T _C = 25°C	I _F	50	А
Diode Forward Current	T _C = 100°C	I _F	30	А
Diode Pulsed Forward Current	I _{FP} ^{*1}	150	А	
$T_c = 25^{\circ}C$		P _D	277	W
Power Dissipation	T _C = 100°C	P _D	138	W
Operating Junction Temperature		Tj	-40 to +175	°C
Storage Temperature	T _{stg}	-55 to +175	°C	
*1 Pulse width limited by T				

*1 Pulse width limited by T_{jmax.}

•Thermal Resistance

Parameter	Symbol	Values			Unit
Faranieter	Symbol	Min.	Тур.	Max.	Unit
Thermal Resistance IGBT Junction - Case	$R_{\theta(j-c)}$	-	-	0.54	°C/W
Thermal Resistance Diode Junction - Case	$R_{\theta(j-c)}$	-	-	1.42	°C/W

●IGBT Electrical Characteristics (at T_j = 25°C unless otherwise specified)

Parameter	Symbol Conditions		Values			Unit	
Farameter	Symbol	Conditions	Min. Typ.		Max.	Unit	
Collector - Emitter Breakdown Voltage	BV _{CES}	I _C = 10μΑ, V _{GE} = 0V	650	-	-	V	
Collector Cut - off Current	I _{CES}	V _{CE} = 650V, V _{GE} = 0V	-	-	10	μA	
Gate - Emitter Leakage Current	I _{GES}	V _{GE} = ±30V, V _{CE} = 0V	-	-	±200	nA	
Gate - Emitter Threshold Voltage	V _{GE(th)}	V _{CE} = 5V, I _C = 34.7mA	5.0	6.0	7.0	V	
Collector - Emitter Saturation Voltage	V _{CE(sat)}	I _C = 50A, V _{GE} = 15V T _j = 25°C T _j = 175°C	-	1.65 2.2	2.1 -	V	

•IGBT Electrical Characteristics (at $T_j = 25^{\circ}C$ unless otherwise specified)

Deveneter	Cumhal Candiliana		Values				
Parameter	Symbol	Conditions	Min. Typ. Max.		Max.	– Unit	
Input Capacitance	C _{ies}	V _{CE} = 30V	-	2770	-		
Output Capacitance	C _{oes}	V _{GE} = 0V	-	106	-	pF	
Reverse Transfer Capacitance	C _{res}	f = 1MHz	-	43	-		
Total Gate Charge	Qg	V _{CE} = 300V	-	94	-		
Gate - Emitter Charge	Q_{ge}	I _C = 50A	-	22	-	nC	
Gate - Collector Charge	Q_{gc}	V _{GE} = 15V	-	31	-		
Turn - on Delay Time	t _{d(on)}	I _C = 50A, V _{CC} = 400V	-	42	-		
Rise Time	t _r	V_{GE} = 15V, R_G = 10 Ω	-	68	-		
Turn - off Delay Time	t _{d(off)}	T _j = 25°C	-	137	-	ns	
Fall Time	t _f	Inductive Load	-	62	-		
Turn - on Delay Time	t _{d(on)}	I _C = 50A, V _{CC} = 400V	-	42	-		
Rise Time	t _r	V_{GE} = 15V, R_G = 10 Ω	-	68	-		
Turn - off Delay Time	$t_{d(off)}$	T _j = 175°C	-	149	-	ns	
Fall Time	t _f	Inductive Load	-	76	-		
		I _C = 150A, V _{CC} = 520V					
Reverse Bias Safe Operating Area	RBSOA	$V_{P} = 650V, V_{GE} = 15V$	FU	LL SQUA	RE	-	
		R _G = 50Ω, T _j = 175°C					
		$V_{CC} \leq 360V$					
Short Circuit Withstand Time	t _{sc}	V _{GE} = 15V	5	-	-	μs	
		T _j = 25°C					

•FRD Electrical Characteristics (at $T_j = 25^{\circ}C$ unless otherwise specified)

Deremeter	Symbol	Conditions	Values			Unit	
Parameter	Parameter Symbol Conditions		Min. Typ. Max		Max.		
Diode Forward Voltage	V _F	I _F = 30A T _j = 25°C T _j = 175°C	-	1.45 1.25	2.0	V	
Diode Reverse Recovery Time	t _{rr}	I _F = 30A	-	54	-	ns	
Diode Peak Reverse Recovery Current	I _{rr}	V _{CC} = 400V di _F /dt = 200A/µs T _j = 25°C	-	7.4	-	А	
Diode Reverse Recovery Charge	Q _{rr}		-	0.22	-	μC	
Diode Reverse Recovery Time	t _{rr}	I _F = 30A	-	225	-	ns	
Diode Peak Reverse Recovery Current	I _{rr}	V _{CC} = 400V di _F /dt = 200A/µs	-	12.8	-	А	
Diode Reverse Recovery Charge	Q _{rr}	T _j = 175°C	-	1.60	-	μC	

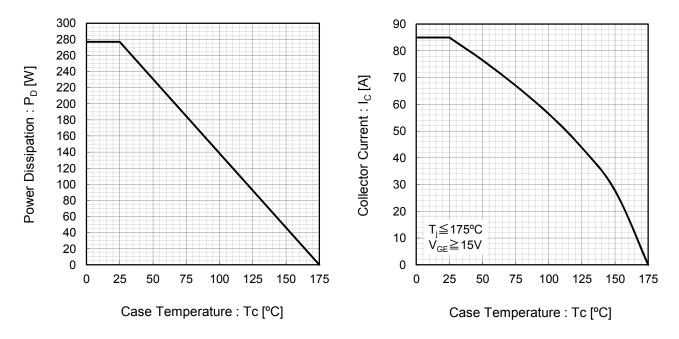
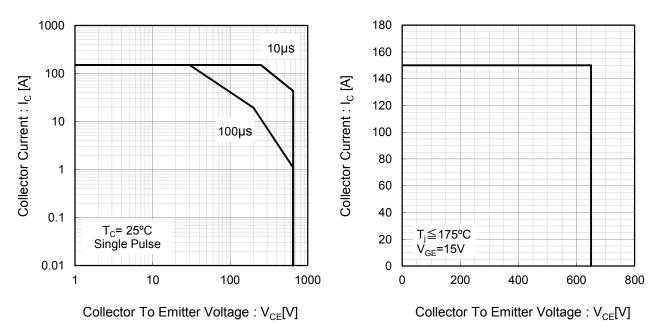


Fig.1 Power Dissipation vs. Case Temperature

Fig.2 Collector Current vs. Case Temperature

Fig.3 Forward Bias Safe Operating Area

Fig.4 Reverse Bias Safe Operating Area



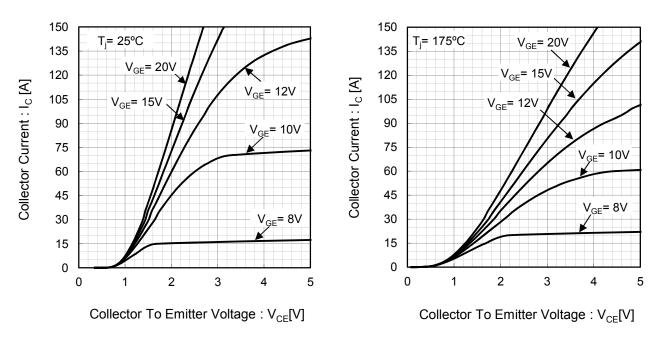


Fig.5 Typical Output Characteristics

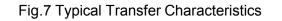


Fig.8 Typical Collector To Emitter Saturation Voltage vs. Junction Temperature

Fig.6 Typical Output Characteristics

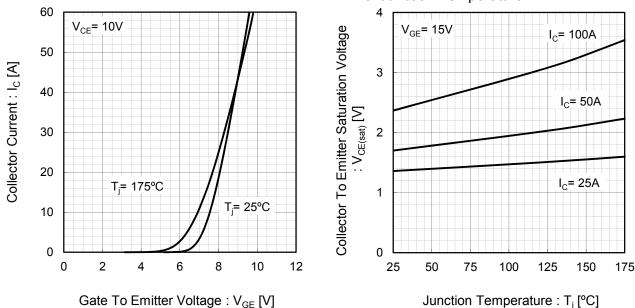


Fig.10 Typical Collector To Emitter Saturation Voltage

•Electrical Characteristic Curves

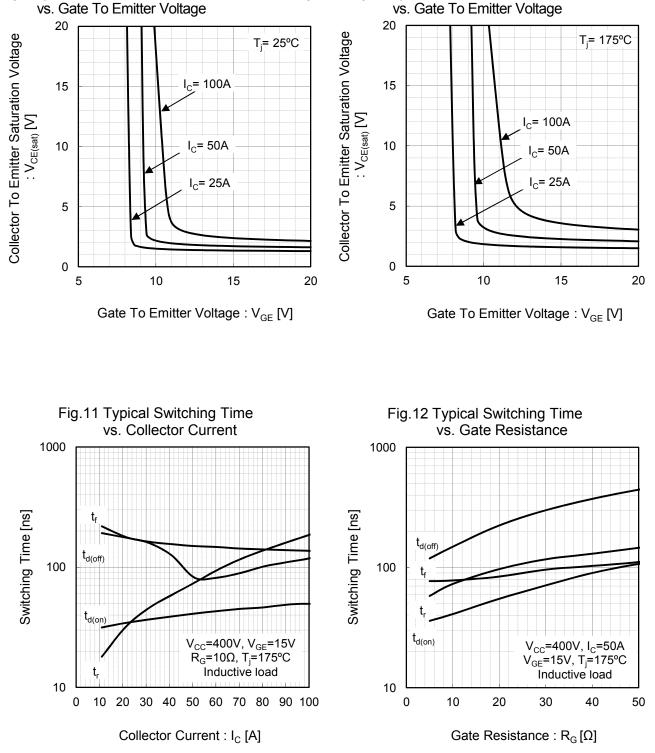
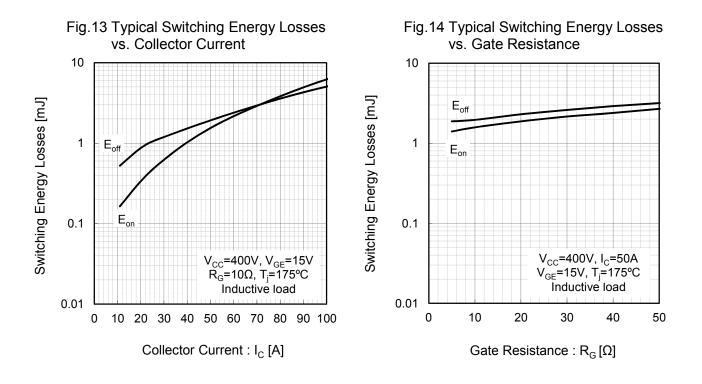


Fig.9 Typical Collector To Emitter Saturation Voltage vs. Gate To Emitter Voltage



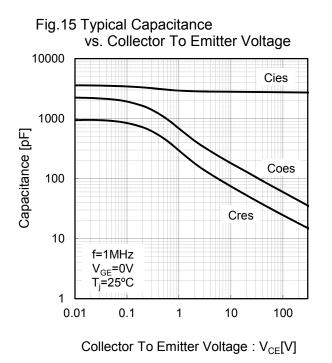
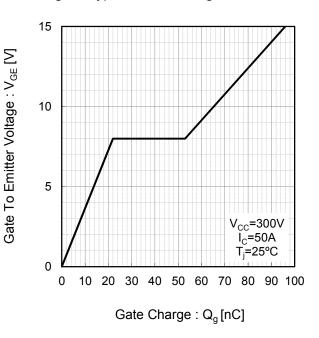


Fig.16 Typical Gate Charge



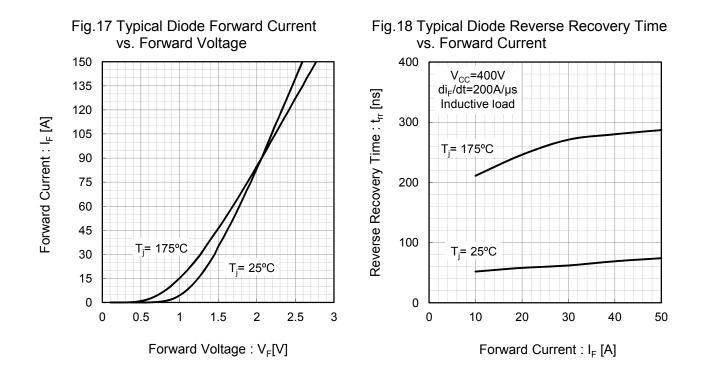


Fig.19 Typical Diode Reverse Recovery Current vs. Forward Current

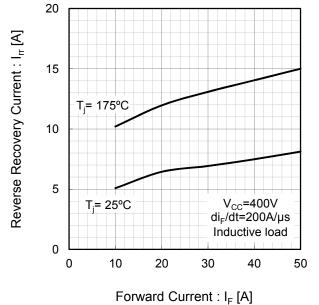
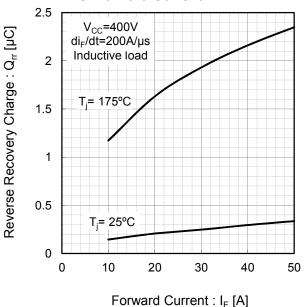


Fig.20 Typical Diode Reverse Recovery Charge vs. Forward Current



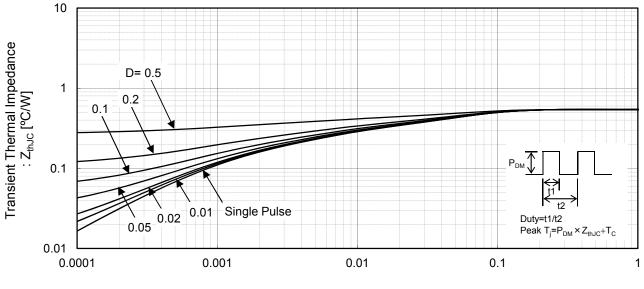


Fig.21 IGBT Transient Thermal Impedance



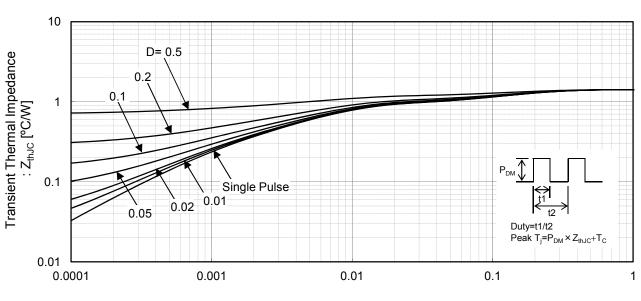


Fig.22 Diode Transient Thermal Impedance

Pulse Width : t1[s]

●Inductive Load Switching Circuit and Waveform

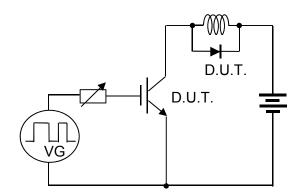


Fig.23 Inductive Load Circuit

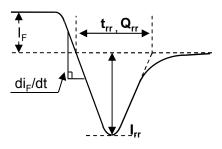


Fig.25 Diode Reverce Recovery Waveform

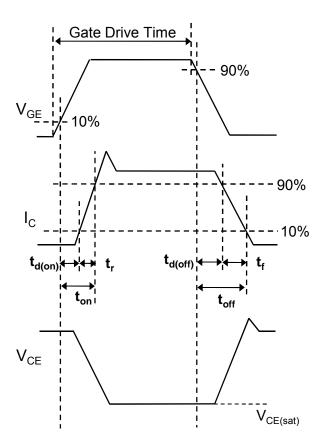


Fig.24 Inductive Load Waveform

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Distribution Inventory

Part Number	rgt00ts65d
Package	TO-247N
Unit Quantity	450
Minimum Package Quantity	450
Packing Type	Bulk
Constitution Materials List	inquiry
RoHS	Yes